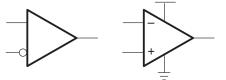
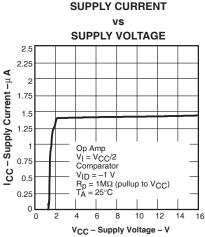
- Micro-Power Operation ... 1.4 μA
- Input Common-Mode Range Exceeds the Rails ... –0.1 V to V_{CC} + 5 V
- Supply Voltage Range . . . 2.5 V to 16 V
- Rail-to-Rail Input/Output (Amplifier)
- Reverse Battery Protection Up to 18 V
- Gain Bandwidth Product . . . 5.5 kHz (Amplifier)
- Open-Drain CMOS Output Stage (Comparator)
- Specified Temperature Range
 T_A = -40°C to 125°C . . . Industrial Grade
- Ultrasmall Packaging
 8-Pin MSOP (TLV2302)
- Universal Op-Amp EVM (See the SLOU060 for More Information)





The TLV230x combines sub-micropower operational amplifier and comparator into a single package that produces excellent micropower signal conditioning with only 1.4 μ A of supply current. This combination gives the designer more board space and reduces part counts in systems that require an operational amplifier and comparator. The low supply current makes it an ideal choice for battery-powered portable applications where quiescent current is the primary concern. Reverse battery protection guards the amplifier from an over-current condition due to improper battery installation. For harsh environments, the inputs can be taken 5 V above the positive supply rail without damage to the device.

The TLV230x's low supply current is coupled with extremely low input bias currents enabling them to be used with mega-ohm resistors making them ideal for portable, long active life, applications. DC accuracy is ensured with a low typical offset voltage as low as 390 μ V, CMRR of 90 dB and minimum open loop gain of 130 V/mV at 2.7 V.

The maximum recommended supply voltage is as high as 16 V and ensured operation down to 2.5 V, with electrical characteristics specified at 2.7 V, 5 V, and 15 V. The 2.5-V operation makes it compatible with Li-Ion battery-powered systems and many micropower microcontrollers available today including TI's MSP430.

All members are available in PDIP and SOIC with the duals (one op-amp and one comparator) in the small MSOP package, and the quads (two operational amplifiers and two comparators) in the TSSOP package.

| DEVICE | V _{CC} (V) | V _{IO} (μV) | I _{CC} /Ch (μA) | GBW (kHz) | SR (V/µs) | tPLH (μ s) | ^t PHL (μs) | t _f (μs) | RAIL-TO- RAIL | OUTPUT STAGE | | |
|---------|------------------------|-------------------------|-----------------------------|--------------|--------------|------------------------------|--------------------------|------------------------|------------------|-----------------|--|--|
| TLV230x | 2.5 – 16 | 390 | 1.4‡ | 5.5 | 0.0025 | 55 | 30 | 5 | I/O | OD | | |
| TLV270x | 2.5 – 16 | 390 | 1.4‡ | 5.5 | 0.0025 | 55 | 30 | 5 | I/O | PP | | |
| TLV240x | 2.5 – 16 | 390 | 880 | 5.5 | 0.0025 | — | — | — | I/O | — | | |
| TLV224x | 2.5 – 12 | 600 | 1 | 5.5 | 0.002 | — | — | — | I/O | — | | |
| TLV340x | 2.5 – 16 | 250 | 0.47 | — | — | 55 | 30 | 5 | I | OD | | |
| TLV370x | 2.5 – 16 | 250 | 0.47 | _ | _ | 55 | 30 | 5 | I | PP | | |

[†] All specifications are typical values measured at 5 V.

[‡]I_{CC} is specified as one op-amp and one comparator.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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TLV2302 AVAILABLE OPTIONS

| | | | PACKAGED D | EVICES | |
|----------------|---------|---------------------------------|----------------|-------------|-----|
| Та | | | MSO | PLASTIC DIP | |
| 'A | AT 25°C | (D) | MSOP† (DGK) | SYMBOLS | (P) |
| -40°C to 125°C | 4000 μV | V TLV2302ID TLV2302IDGK xxTIAQG | | TLV2302IP | |

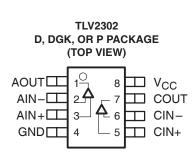
[†] This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2302IDR).

TLV2304 AVAILABLE OPTIONS

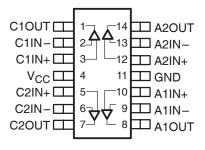
| _ | N | PA | CKAGED DEVICES | |
|----------------|--------------------------------|-----------------------------------|----------------|--------------------|
| ТА | V _{IO} max AT 25°C | SMALL OUTLINE [†] (D) | TSSOP (PW) | PLASTIC DIP (N) |
| -40°C to 125°C | 4000 μV | TLV2304ID | TLV2304IPW | TLV2304IN |

[†] This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2304IDR).

TLV230x PACKAGE PINOUTS









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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| Supply voltage, V _{CC} (see Note 1) | |
|---|------------------------------|
| Input voltage range, VI (see Notes 1 and 2) | |
| Input current range, I _I (any input) | ±10 mA |
| Output current range, IO | ±10 mA |
| Continuous total power dissipation | See Dissipation Rating Table |
| Operating free-air temperature range, T _A : I suffix | 10°C to 125°C |
| | |
| Maximum junction temperature, T _J | |
| | 150°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to GND

2. Input voltage range is limited to 20 V max or V_{CC} + 5 V, whichever is smaller.

| | DISSIPATION RATING TABLE | | | | | | | | | |
|---------|--------------------------|---------------|---------------------------------------|--|--|--|--|--|--|--|
| PACKAGE | ⊖JC (°C/W) | ⊖JA (°C/W) | T _A ≤ 25°C POWER RATING | T _A = 125°C POWER RATING | | | | | | |
| D (8) | 38.3 | 176 | 710 mW | 142 mW | | | | | | |
| D (14) | 26.9 | 122.3 | 1022 mW | 204.4 mW | | | | | | |
| DGK (8) | 54.2 | 259.9 | 481 mW | 96.2 mW | | | | | | |
| N (14) | 32 | 78 | 1600 mW | 320.5 mW | | | | | | |
| P (8) | 41 | 104 | 1200 mW | 240.4 mW | | | | | | |
| PW (14) | 29.3 | 173.6 | 720 mW | 144 mW | | | | | | |

DISSIPATION BATING TABLE

recommended operating conditions

| | | MIN | MAX | UNIT |
|---------------------------------------|--------------------------|-------|--------------------|------|
| | Single supply | 2.5 | 16 | V |
| Supply voltage, V _{CC} | Split supply | ±1.25 | ±8 | v |
| Common-mode input voltage range, VICR | Amplifier and comparator | -0.1 | V _{CC} +5 | V |
| Operating free-air temperature, TA | | -40 | 125 | °C |



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electrical characteristics at recommended operating conditions, V_{CC} = 2.7, 5 V, and 15 V (unless otherwise noted)

amplifier dc performance

| | PARAMETER | TEST CONDIT | IONS | TA | MIN | TYP | MAX | UNIT |
|--------|-----------------------------------|--|--|------------|-----|------|------|--------|
| Vie | Input offset voltage | $V_{O} = V_{CC}/2 V$, | | 25°C | | 390 | 4000 | μV |
| VIO | input onset voltage | $V_{IC} = V_{CC}/2 V,$ | | Full range | | | 6000 | μv |
| ανιο | Offset voltage draft | R _S = 50 Ω | | 25°C | | 3 | | μV/°C |
| | | | V _{CC} = 2.7 V | 25°C | 55 | 73 | | |
| | | | VCC = 2.7 V | Full range | 52 | | | |
| CMRR | Common mode rejection ratio | $V_{IC} = 0$ to V_{CC} , | V _{CC} = 5 V | 25°C | 60 | 80 | | dB |
| Civinn | Common-mode rejection ratio | R _S = 50 Ω | | Full range | 55 | | | aв |
| | | | V _{CC} = 15 V | 25°C | 66 | 90 | | |
| | | | | Full range | 60 | | | |
| | | 1 = -271 + 161 = -151 | $P_{\rm H} = 500 \rm kO$ | 25°C | 130 | 400 | | |
| | | $v_{CC} = 2.7 v, v_{O(pp)} = 1.5 v_{O(pp)}$ | $V_{CC} = 2.7 \text{ V}, V_{O(pp)} = 1.5 \text{ V}, R_{L} = 500 \text{ k}\Omega$ | | 30 | | | |
| A. (= | Large-signal differential voltage | | $P_{\rm L} = 500 k_{\rm O}$ | 25°C | 300 | 1000 | | V/mV |
| AVD | amplification | $V_{CC} = 5 V$, $V_{O(pp)} = 3 V$, | HL = 200 K22 | Full range | 100 | | | V/IIIV |
| | | | $P_{\rm b} = 500 \rm kO$ | 25°C | 400 | 1400 | | |
| | | $V_{CC} = 15 \text{ V}, V_{O(pp)} = 8 \text{ V},$ | HL = 500 K22 | Full range | 120 | | | |
| | | | | 25°C | 90 | 120 | | |
| PSRR | Power supply rejection ratio | $V_{IC} = V_{CC}/2 V$, No load | V _{CC} = 2.7 to 5 V | Full range | 85 | | | dD |
| FORR | $(\Delta V_{CC}/\Delta V_{IO})$ | | | 25°C | 94 | 120 | | dB |
| | | | $V_{CC} = 5$ to 15 V | Full range | 90 | | | |

[†]Full range is -40°C to 125°C.

amplifier and comparator input characteristics

| | PARAMETER | TEST CONDITIONS | т _А † | MIN | TYP | MAX | UNIT |
|-------------------|--------------------------------------|---|------------------|-----|-----|------|------|
| | | | | | 25 | 250 | |
| IIO | I _{IO} Input offset current | $V_{0} = V_{0} = V_{0}$ | 0 to 70°C | | | 300 | pА |
| | | $V_{O} = V_{CC}/2 V,$ $V_{IC} = V_{CC}/2 V,$ | Full range | | | 500 | |
| | | $R_p = 1 M\Omega$ (pullup to V _{CC}), | 25°C | | 100 | 500 | |
| IIB | Input bias current | $R_{S} = 50 \Omega$ | 0 to 70°C | | | 550 | pА |
| | | | Full range | | | 1000 | |
| ri(d) | Differential input resistance | | 25°C | | 300 | | MΩ |
| C _{i(c)} | Common-mode input capacitance | f = 100 kHz | 25°C | | 3 | | pF |

[†]Full range is -40°C to 125°C.



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electrical characteristics at recommended operating conditions, V_{CC} = 2.7, 5 V, and 15 V (unless otherwise noted) (continued)

amplifier output characteristics

| | PARAMETER | TEST CON | IDITIONS | т _А † | MIN | ТҮР | MAX | UNIT |
|-------------------|---------------------------|--|-------------------------|------------------|-------|-------|-----|------|
| | | | V _{CC} = 2.7 V | 25°C | 2.55 | 2.65 | | |
| V _{OH} н | | | VCC = 2.7 V | Full range | 2.5 | | | |
| | High lovel output voltage | $V_{IC} = V_{CC}/2$, | V _{CC} = 5 V | 25°C | 4.85 | 4.95 | | v |
| | High-level output voltage | $V_{IC} = V_{CC}/2,$ $I_{OH} = -50 \ \mu A$ | | Full range | 4.8 | | | |
| | | | V | 25°C | 14.85 | 14.95 | | |
| | | V _{CC} = 15 V | | Full range | 14.8 | | | |
| Ve | | | | 25°C | | 180 | 260 | mV |
| VOL | Low-level output voltage | $V_{\text{IC}} = V_{\text{CC}}/2$, IC |)[= 50 μΑ | Full range | | | 300 | mv |
| 10 | Output current | $V_{O} = 0.5 V$ from | rail | 25°C | | ±200 | | μA |

[†]Full range is -40°C to 125°C.

amplifier dynamic performance

| | PARAMETER | TEST CONDITIO | NS | Тд | MIN TYP | MAX | UNIT |
|----------------|--------------------------------|---|-------------------------|--------|---------|-----|------------------|
| UGBW | Unity gain bandwidth | R _L = 500 kΩ, | C _L = 100 pF | 25°C | 5.5 | | kHz |
| SR | Slew rate at unity gain | $V_{O(pp)} = 0.8 V$, $R_L = 500 k\Omega$, | C _L = 100 pF | 25°C | 2.5 | | V/ms |
| φM | Phase margin | $R_{I} = 500 \text{ k}\Omega$, $C_{I} = 100 \text{ pF}$ | | 25°C | 60° | | |
| | Gain margin | $H_{L} = 500 \text{ ksz}, C_{L} = 100 \text{ pr}$ | | 25 0 | 15 | | dB |
| | Settling time | $ \begin{array}{ll} V_{CC} = 2.7 \mbox{ or } 5 \mbox{ V}, \\ V_{(STEP)PP} = 1 \mbox{ V}, & C_L = 100 \mbox{ pF}, \\ A_V = -1, & R_L = 100 k\Omega \end{array} $ | 0.1% | • 25°C | 1.84 | | |
| ts | | $V_{CC} = 15 V,$ | 0.1% | 25'0 | 6.1 | | ms |
| | | $\label{eq:stepperturbative} \begin{array}{ll} V(\text{STEP})\text{PP} = 1 \ \text{V}, & \text{C}_L = 100 \ \text{pF}, \\ \text{A}_V = -1, & \text{R}_L = 100 \ \text{k}\Omega \end{array}$ | 0.01% | | 32 | | |
| N. | Equivalent input noise | f = 0.1 to 10 Hz | f = 0.1 to 10 Hz | | | | μV _{pp} |
| Vn | voltage | f = 100 Hz | | 25°C | 500 | | nV/√Hz |
| I _n | Equivalent input noise current | f = 100 Hz | | 25°C | 8 | | fA/√Hz |

supply current

| | PARAMETER | TEST CO | NDITIONS | T _A † | MIN | ΤΥΡ | MAX | UNIT |
|-----|--|--|----------------------------------|------------------|-----|-----|-----|------|
| | • • • • • • | R _p = No pullup, Output state high | $V_{CC} = 2.7 V \text{ or } 5 V$ | 25°C | | 1.4 | | |
| Icc | ICC Supply current (one op-amp and one comparator) | | Vcc = 15 V | 25°C | | 1.4 | 1.7 | μA |
| | comparatory | Output state high | ACC = 12 A | Full range | | | 2.3 | |
| | Reverse supply current | $V_{CC} = -18 V, V_{I} = 0$ | 0 V, V _O = open | 25°C | | 50 | | nA |

[†]Full range is –40°C to 125°C.



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electrical characteristics at recommended operating conditions, V_{CC} = 2.7, 5 V, and 15 V (unless otherwise noted) (continued)

comparator dc performance

| | PARAMETER | TEST CONDITIONS [†] | | | MIN | ТҮР | MAX | UNIT |
|------|--|--|---|------------|-----|------|------|-------|
| Vie | Input offset voltage | | | 25°C | | 250 | 5000 | μV |
| VIO | input onset voltage | $V_{IC} = V_{CC}/2$, $R_S = 50$ $R_p = 1 M\Omega$ (pullup to V_C | $V_{IC} = V_{CC}/2$, $R_S = 50 \Omega$, | | | | 7000 | μv |
| ανιο | Offset voltage drift | | 0) | 25°C | | 3 | | μV/°C |
| | | | | 25°C | 55 | 72 | | |
| | | V_{IC} = 0 to V_{CC} , R _S = 50 Ω | $V_{CC} = 2.7 V$ | Full range | 50 | | | |
| CMRR | Common-mode rejection ratio | | V _{CC} = 5 V | 25°C | 60 | 76 | | dB |
| CMRR | | | | Full range | 55 | | | |
| | | | V = = 15 V | 25°C | 65 | 88 | | |
| | | | V _{CC} = 15 V | Full range | 60 | | | |
| AVD | Large-signal differential voltage amplification | $R_p = 1 M\Omega$ (pullup to V_C | C) | 25°C | | 1000 | | V/mV |
| | | | | 25°C | 75 | 100 | | |
| PSRR | Power supply rejection ratio $(\Delta V_{CC}/\Delta V_{IO})$ | $V_{IC} = V_{CC}/2 V$, | V _{CC} = 2.7 to 5 V | Full range | 70 | | | dB |
| FSRR | | No load | | 25°C | 85 | 105 | | uВ |
| | | | V _{CC} = 5 to 15 V | Full range | 80 | | | |

[†]Full range is -40°C to 125°C.

comparator output characteristics

| | PARAMETER | TES | r conditions† | T _A † | MIN | ТҮР | MAX | UNIT |
|-----|--|----------------------|--|------------------|-----|-----|-----|------|
| IOZ | High-impedance output leakage current | $V_{IC} = V_{CC}/2,$ | $V_O = V_{CC}, V_{ID} = 1 V$ | 25°C | | 50 | | pА |
| Vai | | | | 25°C | | 80 | 200 | m\/ |
| VOL | Low-level output voltage | $V_{IC} = V_{CC}/2,$ | $I_{OL} = 50 \ \mu A, \ V_{ID} = -1 \ V$ | Full range | | | 300 | mV |

[†] Full range is -40°C to 125°C.

switching characteristics at recommended operating conditions, V_{CC} = 2.7 V, 5 V, 15 V (unless otherwise noted)

| | PARAMETER TEST CONDITIONS | | | Тд | MIN | ТҮР | MAX | UNIT |
|--|---|---|-------------------|------|-----|-----|-----|------|
| | - | | Overdrive = 2 mV | | | 175 | | |
| t(PLH) Propagation delay time, low-to-high-level output | f = 10 kHz, Overdrive = 10 mV 25°C | | | 55 | | | | |
| | low to high lover output | $V_{\text{STEP}} = 1 \text{ V},$ | Overdrive = 50 mV | | | 25 | | |
| | | $C_{L} = 10 \text{ pF},$ | Overdrive = 2 mV | | 300 | | | μs |
| ^t (PHL) | Propagation delay time, high-to-low-level output | $R_p = 1 M\Omega$ (pullup to V_{CC}) | Overdrive = 10 mV | 25°C | | 60 | | |
| | high to low level output | | Overdrive = 50 mV | | | 30 | | |
| tf | Fall time | C _L = 10 pF | | 25°C | | 5 | | μs |

NOTE: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.



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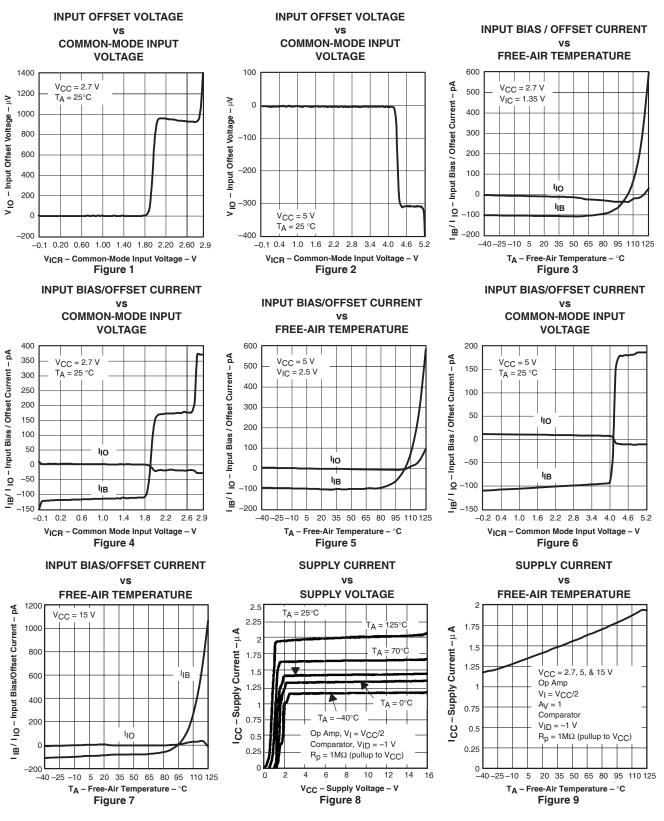
TYPICAL CHARACTERISTICS

Table of Graphs

| | | | FIGURE |
|-----------------|--|------------------------------|---------|
| VIO | Input offset voltage | vs Common-mode input voltage | 1, 2 |
| | Input bias current | vs Free-air temperature | 3, 5, 7 |
| IВ | Input bias current | vs Common-mode input voltage | 4, 6 |
| l. e | Input offset current | vs Free-air temperature | 3, 5, 7 |
| 10 | input onset current | vs Common-mode input voltage | 4, 6 |
| | Supply current | vs Supply voltage | 8 |
| ICC | Supply current | vs Free-air temperature | 9 |
| Amplifier | | | |
| CMRR | Common-mode rejection ratio | vs Frequency | 10 |
| VOH | High-level output voltage | vs High-level output current | 11, 13 |
| VOL | Low-level output voltage | vs Low-level output current | 12, 14 |
| VO(PP) | Output voltage, peak-to-peak | vs Frequency | 15 |
| PSRR | Power supply rejection ratio | vs Frequency | 16 |
| | Voltage noise over a 10 Second Period | | 17 |
| [¢] m | Phase margin | vs Capacitive load | 18 |
| A _{VD} | Differential voltage gain | vs Frequency | 19 |
| | Phase | vs Frequency | 19 |
| | Gain bandwidth product | vs Supply voltage | 20 |
| SR | Slew rate | vs Free-air temperature | 21 |
| | Large signal follower pulse response | | 22 |
| | Small signal follower pulse response | | 23 |
| | Large signal inverting pulse response | | 24 |
| | Small signal inverting pulse response | | 25 |
| Comparator | | | |
| VOL | Low-level output voltage | vs Low-level output current | 26, 27 |
| | Open collector leakage current | vs Free-air temperature | 28 |
| | Output fall time | vs Supply voltage | 29 |
| | Low-to-high level output response for various input overdrives | | 30, 31 |
| | High-to-low level output response for various input overdrives | | 32, 33 |



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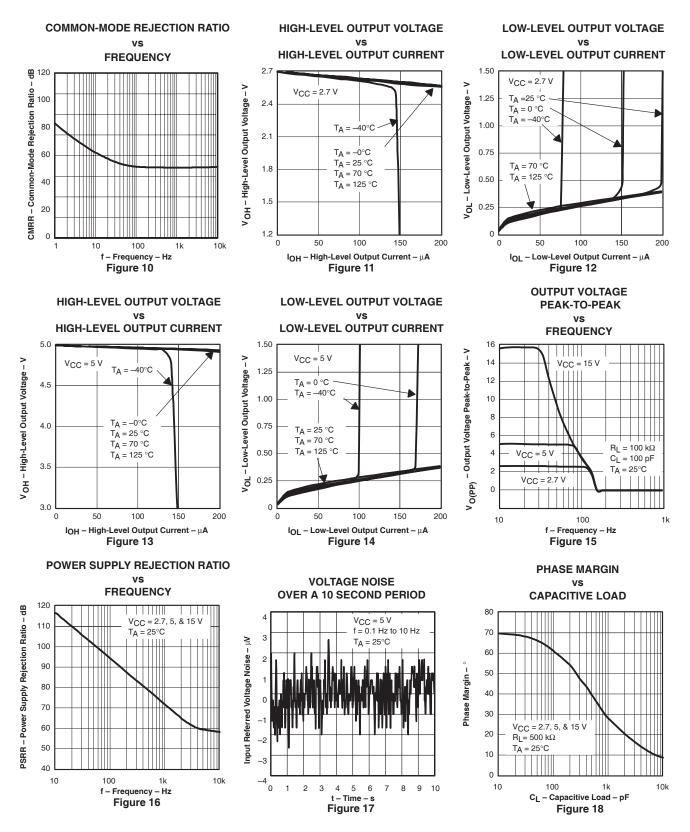


AMPLIFIER AND COMPARATOR TYPICAL CHARACTERISTICS

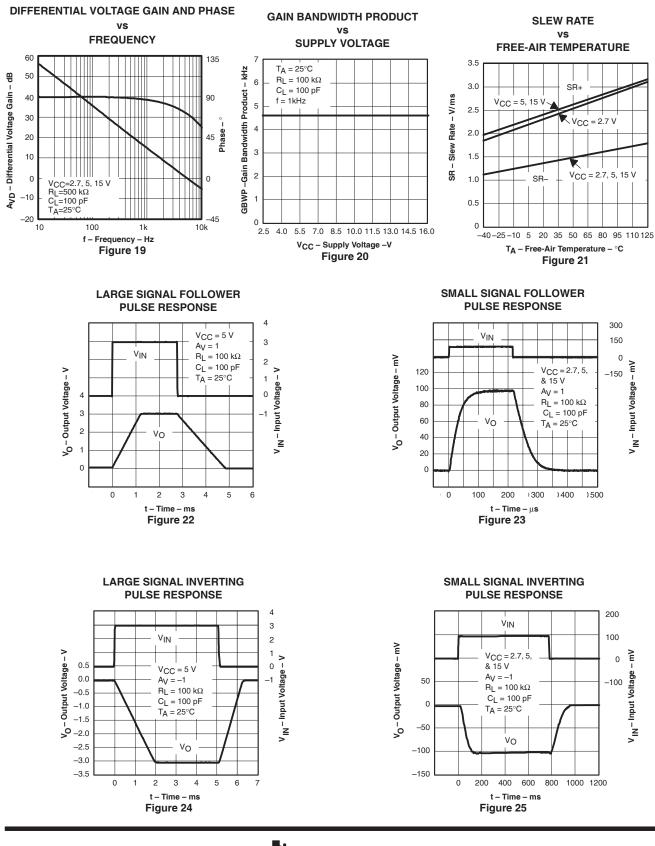


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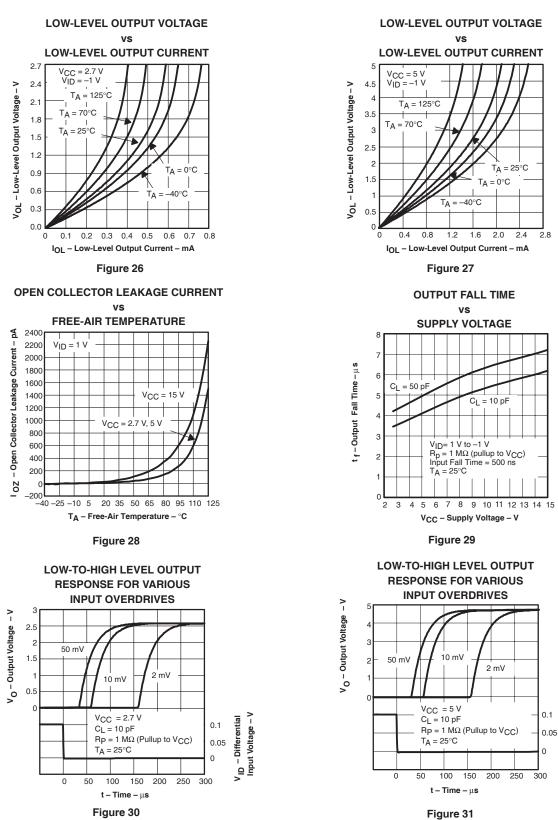
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AMPLIFIER TYPICAL CHARACTERISTICS

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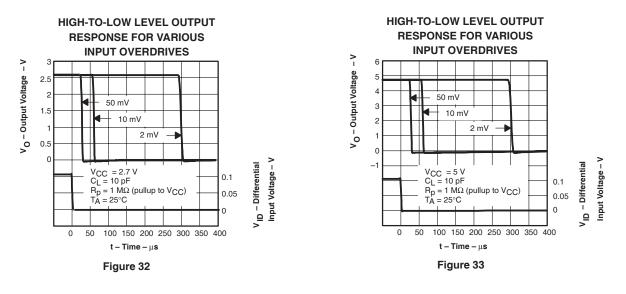




Input Voltage – V

V_{ID} – Differential

COMPARATOR TYPICAL CHARACTERISTICS



APPLICATION INFORMATION

reverse battery protection

The TLV2302/4 is protected against reverse battery voltage up to 18 V. When subjected to reverse battery condition, the supply current is typically less than 100 nA at 25°C (inputs grounded and outputs open). This current is determined by the leakage of six Schottky diodes and will therefore increase as the ambient temperature increases.

When subjected to reverse battery conditions and negative voltages applied to the inputs or outputs, the input ESD structure will turn on—this current should be limited to less than 10 mA. If the inputs or outputs are referred to ground, rather than midrail, no extra precautions need be taken.

common-mode input range

The TLV2302/4 has rail-rail input and outputs. For common-mode inputs from -0.1 V to V_{CC} -0.8 V a PNP differential pair will provide the gain.

For inputs between V_{CC} – 0.8 V and V_{CC} , two NPN emitter followers buffering a second PNP differential pair provide the gain. This special combination of NPN/PNP differential pair enables the inputs to be taken 5 V above the rails; because as the inputs go above V_{CC} , the NPNs switch from functioning as transistors to functioning as diodes. This will lead to an increase in input bias current. The second PNP differential pair continues to function normally as the inputs exceed V_{CC} .

The TLV2302/4 has a negative common-input range that exceeds ground by 100 mV. If the inputs are taken much below this, reduced open loop gain will be observed with the ultimate possibility of phase inversion.

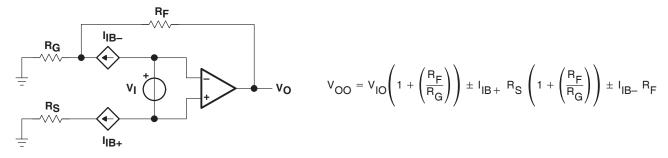


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APPLICATION INFORMATION

offset voltage

The output offset voltage, (V_{OO}) is the sum of the input offset voltage (V_{IO}) and both input bias currents (I_{IB}) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage.





general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 35).

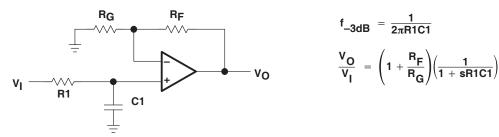
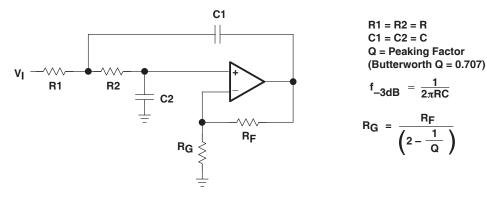


Figure 35. Single-Pole Low-Pass Filter

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.







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APPLICATION INFORMATION

circuit layout considerations

To achieve the levels of high performance of the TLV230x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- Ground planes—It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- Proper power supply decoupling—Use a 6.8-µF tantalum capacitor in parallel with a 0.1-µF ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a 0.1-µF ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the 0.1-µF capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- Sockets—Sockets can be used but are not recommended. The additional lead inductance in the socket pins will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board is the best implementation.
- Short trace runs/compact part placements-Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This will help to minimize stray capacitance at the input of the amplifier.
- Surface-mount passive components—Using surface-mount passive components is recommended for high performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be kept as short as possible.



APPLICATION INFORMATION

general power dissipation considerations

For a given θ_{JA} , the maximum power dissipation is shown in Figure 37 and is calculated by the following formula:

$$\mathsf{P}_{\mathsf{D}} = \left(\frac{\mathsf{T}_{\mathsf{M}\mathsf{A}\mathsf{X}}^{-\mathsf{T}}\mathsf{A}}{{}^{\theta}\mathsf{J}\mathsf{A}}\right)$$

Where:

P_D = Maximum power dissipation of TLV230x IC (watts)

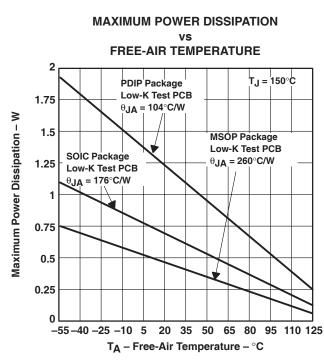
 T_{MAX} = Absolute maximum junction temperature (150°C)

 T_A = Free-ambient air temperature (°C)

 $\theta_{JA} = \theta_{JC} + \theta_{CA}$

 θ_{JC} = Thermal coefficient from junction to case

 θ_{CA} = Thermal coefficient from case to ambient air (°C/W)









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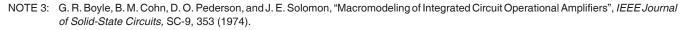
APPLICATION INFORMATION

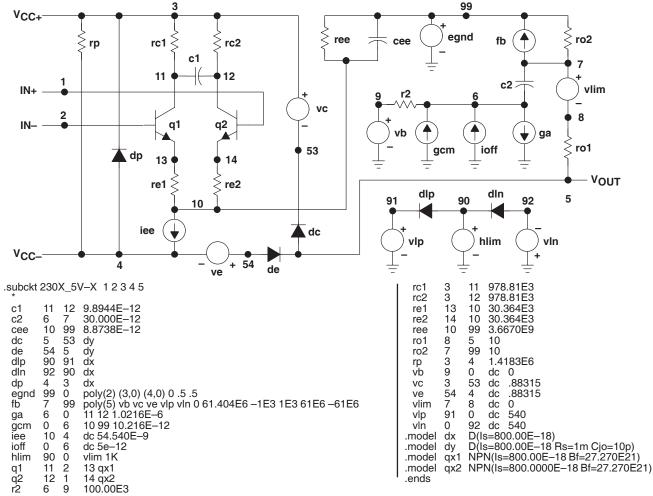
amplifier macromodel information

Macromodel information provided was derived using Microsim Parts™ Release 8, the model generation software used with Microsim PSpice™. The Boyle macromodel (see Note 2) and subcircuit in Figure 38 are generated using the TLV230x typical electrical and operating characteristics at T_A = 25°C. Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification

- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit







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PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| | | | | | | | (6) | | | | |
| TLV2302ID | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 23021 | Samples |
| TLV2302IDGK | ACTIVE | VSSOP | DGK | 8 | 80 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | AQG | Samples |
| TLV2302IDGKR | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | AQG | Samples |
| TLV2302IDR | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 23021 | Samples |
| TLV2302IP | ACTIVE | PDIP | Р | 8 | 50 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 125 | TLV23021 | Samples |
| TLV2304ID | ACTIVE | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 23041 | Samples |
| TLV2304IDR | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 23041 | Samples |
| TLV2304IN | ACTIVE | PDIP | Ν | 14 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -40 to 125 | TLV2304I | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



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PACKAGE OPTION ADDENDUM

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

Texas Instruments

*All dimensions are nominal

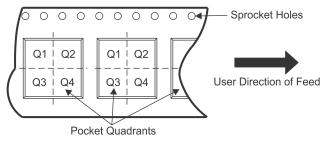
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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| TLV2302IDGKR | VSSOP | DGK | 8 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| TLV2302IDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| TLV2304IDR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |



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PACKAGE MATERIALS INFORMATION

5-Jan-2022



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV2302IDGKR | VSSOP | DGK | 8 | 2500 | 358.0 | 335.0 | 35.0 |
| TLV2302IDR | SOIC | D | 8 | 2500 | 340.5 | 336.1 | 25.0 |
| TLV2304IDR | SOIC | D | 14 | 2500 | 340.5 | 336.1 | 32.0 |



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5-Jan-2022

TUBE



*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|-----------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLV2302ID | D | SOIC | 8 | 75 | 507 | 8 | 3940 | 4.32 |
| TLV2302IP | Р | PDIP | 8 | 50 | 506 | 13.97 | 11230 | 4.32 |
| TLV2304ID | D | SOIC | 14 | 50 | 507 | 8 | 3940 | 4.32 |
| TLV2304IN | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |

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